



LANGUAGE

English

TABLE OF CONTENTS

SECTION	PAGE
1.0 SCOPE	2
2.0 PRODUCT DESCRIPTION AND APPLICABLE DOCUMENTS	3
3.0 RATINGS	4
4.0 ELECTRICAL PERFORMANCE	5
5.0 MECHANICAL PERFORMANCE	6
6.0 ENVIRONMENTAL PERFORMANCE	7-8
7.0 PACKAGING	9
8.0 TEST GROUPS	10
APPENDICES	
APPENDIX A: INSERION/WITHDRAWAL GAUGE SPECIFICATION	11
APPENDIX B: RE-FLOW PROFILES	
APPENDIX C: GLOW WIRE TEST POSITIONS	13

	REVISE ON PC O	NLY:	TITLE:						
Addition of Reverse Footprint parts.				_	_	CTOR SYST		П	
	ECN IPG2013-00	94 D.Byrnes							
2012-Aug-29		THIS DOCUMENT CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX							
REV.	DESCRIP	TION	INC. AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION						
DE	SIGN CONTROL	STATUS	WRITTEN	BY:	CHECKED BY:	APPROV'ED BY	DATE:	YR	/MO/DAY
	MXI RELEASED		J.Denne	hy	D.Waszki'z	J.Dennehy	2007-09-07		
DOCUMENT NUMBER						FILENAME		SHEET	
PS-99020-0011						PS-990200-011		1 of 14	
	ES-40000-3996 REV. A SHEET 3 95/MAR/10 EC U5-0926 DCBRD03.LWP								





LANGUAGEEnglish

1.0 SCOPE

This specification defines the performance characteristics for the PICOFLEX connector system.

	REVISE ON PC ONLY:	TITLE:			
W	SEE SHEET 1		PICOFLEX CONNE PRODUCT SPE		M
			CUMENT CONTAINS INFORMATION TH		
REV.	DESCRIPTION	INC. AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION			
	DOCUMENT NUMBER			FILENAME	SHEET
	PS-99020-0011			PS-99020-0011	2 of 14
	ES-40000-3996 REV. A SHEET 3 95/MAR/10 EC U5-0926 DCBRD03.LWP				





LANGUAGE

English

2.0 PRODUCT DESCRIPTION AND APPLICABLE DOCUMENTS

Product Type	Series No.	Product Description	Sales Drawing			
	90325	Vertical Thru Hole Header	SDA-90325			
	90779	Vertical Thru Hole Header, High Temperature Thermoplastic	SDA-90779			
	90814	90814 Vertical SMT Header				
	93405	Reverse Footprint Vertical SMT Header	SD-93405-001			
PCB Headers	90816	Vertical Latched SMT Header	SD-90816-001			
rCD neaders	93407	Reverse Footprint Vertical Latched SMT Header	SD-93407-001			
	90800	90800 Right-Angle Thru Hole Header				
	91714	Right-Angle Thru Hole Header, High Temperature Thermoplastic	SD-91714-001			
	91330	Bottom Entry SMT Header	SD-91330-001			
IDT	90327	Insulation Displacement Connector	SDA-90327			
Connector	93338	Insulation Displacement Connector (Glow Wire)	SD-93338-001			
90584 Insulation Displacement		Insulation Displacement Board-In Connector	SDA-90584			
Connectors	91577	Insulation Displacement Board-In Connector with Alternative Terminal Stagger	SD-91577-001			

	REVISE ON PC ONLY:	TITLE:				
W	SEE SHEET 1		PICOFLEX CONNEC		M	
		THIS DOCUMENT CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX				
REV.	DESCRIPTION	INC. AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				
	DOCUMENT NUMBER			FILENAME	SHEET	
	PS-99020-0011			PS-99020-0011	3 of 14	
	ES-40000-3996 REV. A SHEET 3 95/MAR/10 EC U5-0926 DCBRD03.LWP					





LANGUAGE

English

3.0 RATINGS

Series No.	Wire/Cable Size (AWG)	Maximum Current at 105°C	Voltage AC/DC	Operating Temperature	Storage Temperature
90325	N/a	1.2A			
90779	N/a	1.2A			
90814 93405	N/a	1.2A			
90816 93407	N/a	1.2A			
90800	N/a	1.2A	250V	-40° (to $+105^{\circ}$ (-40°C to +85°C
91714	N/a	1.2A Max.			
91330	N/a	1.2A			
90327	28 AWG	1.2A			
93338	28 AWG	1.2A			
90584	28 AWG	1.2A			
91577	28 AWG	1.2A			

	REVISE ON PC ONLY:	TITLE:				
W	SEE SHEET 1		PICOFLEX CONNECTOR SYSTEM PRODUCT SPECIFICATION			
			CUMENT CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX			
REV.	DESCRIPTION	INC. AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				
	DOCUMENT NUMBER		FILENAME SHEET			
	PS-99020-0011		PS-99020-0011 4 of 14			
	ES-40000-3996 REV. A SHEET 3 95/MAR/10 EC U5-0926 DCBRD03.LWP					





LANGUAGEEnglish

4.0 ELECTRICAL PERFORMANCE

	ITEM	TEST CONDITION	REQUIREMENT
4.1	Contact Resistance	20mV maximum open circuit voltage. 100mA maximum test current	15mOhms MAXIMUM
4.2	Insulation Resistance	500V DC applied to adjacent circuits	1000 megaOhms MINIMUM
4.3	Dielectric Withstanding Voltage	750 VAC applied to adjacent circuits for 1 minute	No breakdown

	REVISE ON PC ONLY:	TITLE:				
W	SEE SHEET 1		PICOFLEX CONNE PRODUCT SPE		М	
		THIS DOCUMENT CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX				
REV.	DESCRIPTION	INC. AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				
	DOCUMENT NUMBER			FILENAME	SHEET	
	PS-99020-0011			PS-99020-0011	5 of 14	
	ES-40000-3996 REV. A SHEET 3 95/MAR/10 EC U5-0926 DCBRD03.LWP					





LANGUAGE

English

5.0 MECHANICAL PERFORMANCE

	ITEM	TEST CONDITION	REQUIREMENT		
5.1	Insertion Force (Per individual contact, 90327 &	Insertion force tested by inserting standard gauge blade specified in Appendix A	1.7N maximum for initial insertion of Tin contact		
	93338 series only)	Rate of insertion = 25 ± 6 mm/minute	1.5N maximum for initial insertion of PdNi/Gold contact		
5.2	Withdrawal Force (Per individual contact, 90327 &	Withdrawal force tested by withdrawing standard gauge blade specified in Appendix A Rate of withdrawal =25 ±6 mm/minute	Withdrawal force = 0.25N minimum		
	93338 series only)	20 = 0 1111111111			
	Durability	1 durability cycle = 1 Mating & Un-mating of the connector using Picoflex extraction tool or pull-tab	Change in insertion force from initial value = 0.5N maximum		
		For Tin on Tin system number of durability cycles = 30	Change in contact resistance from initial value = 10mOhms		
5.3		For Gold on Gold system number of durability cycles = 100	maximum		
		For PdNi plated product number of durability cycles = 100			
		For 90816/93407 Latched maximum Cycles = 5(Tin or Gold) using Latched Picoflex extraction tool.			
	Shock	Acceleration = 50g	Change in contact resistance		
5.4		Duration = 11 milliseconds	from initial value = 10mOhms maximum		
J. T		Per IEC 512-4, test condition 6c	Discontinuity = 1micro second maximum		
	Vibration	Sweep = 10-55-10Hz	Change in contact resistance		
		Amplitude = 0.35 mm or 5 g	from initial value = 10mOhms maximum		
5.5		Pulse = 1/2 Sine			
		Duration = 2 hours in each X-Y-Z direction Per IEC 512-4, test condition 6d	Discontinuity = 1micro second maximum		
	Terminal Retention	Terminal withdrawal force to be applied at the rate of 25 ± 6 mm per minute	Terminal retention force = 7N minimum.		
5.6	Force in Housing (PCB Headers)	of 23 ± offin per minute	inimitium.		
	Latched header retention force.	Connector retention force to be applied at the rate	Circuit Size Straight R/angle		
		of 25 ± 6 mm per minute.	4 olst 20NI 20NI		
5.8	(Reference only)	Straight and Right angle pull Minimum retention	4ckt 30N 30N 14 ckt 55N 115N		

	REVISE ON PC ONLY:	TITLE:				
W	SEE SHEET 1		PICOFLEX CONNE		M	
		THIS DOCUMENT CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX				
REV.	DESCRIPTION	INC. AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				
	DOCUMENT NUMBER			FILENAME	SHEET	
	PS-99020-0011			PS-99020-0011	6 of 14	
	ES-40000-3996 REV. A SHEET 3 95/MAR/10 EC U5-0926 DCBRD03.LWP					





LANGUAGE

English

6.0 ENVIRONMENTAL PERFORMANCE

	ITEM	TEST CONDITION	REQUIREMENT
6.1	Damp Heat	Mate connectors and expose to: Temperature = +40°C +3/-0°C Humidity = 90 - 95% R.H. Duration = 1000 Hours	Change in contact resistance from initial value = 10mOhms maximum For 93338 series maximum contact resistance after test <50 mOhms No visual damage
6.2	Dry Heat	Mate connectors and expose to: Temperature = +105°C +3/-0°C Duration = 240 Hours	Change in contact resistance from initial value = 10mOhms maximum No visual damage
6.3	Cold	Mate connectors and expose to: Temperature = -40° C +0°C /-3°C Duration = 96 Hours	Change in contact resistance from initial value = 10mOhms maximum No visual damage
6.4	Thermal Shock	Mate connectors and expose to 10 cycles of the following profile: Temperature °C -40 +0 /-3 +20 ± 5 +105 +3/-0 Time Duration 30 minutes 5 minutes max 30 minutes	Change in contact resistance from initial value = 10mOhms maximum No visual damage
6.5	Corrosive Atmosphere Sulphur Dioxide (SO ₂)	Mate Connectors and expose to: Atmosphere: 10 parts per million (PPM) SO ₂ Duration: 240 hours Temperature: 25 °C Humidity: 75% R.H.	Change in contact resistance from initial value = 10mOhms maximum No visual damage
6.6	Corrosive Atmosphere Hydrogen Sulphide (H ₂ S)	Mate Connectors and expose to: Atmosphere: 1 part per million (PPM) H ₂ S Duration: 96 hours Temperature: 25 °C Humidity: 75% R.H.	Change in contact resistance from initial value = 10mOhms maximum No visual damage

	REVISE ON PC ONLY:	TITLE:				
W	SEE SHEET 1		PICOFLEX CONNE PRODUCT SPE		M	
			CUMENT CONTAINS INFORMATION THA			
REV.	DESCRIPTION	INC	C. AND SHOULD NOT BE USED WITHOU	IT WRITTEN PERMIS	SION	
	DOCUMENT NUMBER			FILENAME	SHEET	
	PS-99020-0011			PS-99020-0011	7 of 14	
	ES-40000-3996 REV. A SHEET 3 95/MAR/10 EC U5-0926 DCBRD03.LWP					





LANGUAGE

English

	ITEM	TEST CONDITION	REQUIREMENT
6.7	Solder Heat Resistance 90325, 90584, 90779 90800, 90814/93405*, 91577 and 91714 series only (*90814/93405 standard profile parts).	Insert Terminal Solder Tails in solder bath: Solder Temperature: 230°C Duration: 5 seconds maximum	No damage that would impair normal operation
6.8	Resistance to Reflow Temperature 90814/93405*,90816, 93407 and 91330 series only (* 90814/93405 Low Profile parts only)	Subject unmated connectors to applicable re-flow profile shown in Appendix C	No damage that would impair normal operation
6.9	Glow Wire 90779, 90814,93405,90816,93 407, 91330, 91714 and 93338 series only	Glow wire temperature: 750°C Test positions shown in Appendix D Per IEC 60695-2-11	Flame must extinguish within 2 seconds of removal of glow wire No ignition of wrapping tissue 200mm under test specimen

	REVISE ON PC ONLY:	TITLE:			
W	SEE SHEET 1		PICOFLEX CONNEC		M
			CUMENT CONTAINS INFORMATION THA		
REV.	DESCRIPTION	INC. AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION			
	DOCUMENT NUMBER			FILENAME	SHEET
	PS-99020-0011			PS-99020-0011	8 of 14
ES-40000-3996 REV. A SHEET 3 95/MAR/10 EC U5-0926 DCBRD03.LWP					





LAN	GU	AG	Ε

English

7.0 PACKAGING

Parts shall be packaged to protect against damage during handling, transit and storage. No Styrofoam shall be used in any packing that comes in direct contact with the connectors.

	REVISE ON PC ONLY:	TITLE:			
W	SEE SHEET 1		PICOFLEX CONNE PRODUCT SPE		M
			CUMENT CONTAINS INFORMATION THA		
REV.	DESCRIPTION	INC. AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION			
	DOCUMENT NUMBER			FILENAME	SHEET
	PS-99020-0011			PS-99020-0011	9 of 14
	ES-40000-3996 REV. A SHEET 3 95/MAR/10 EC U5-0926 DCBRD03.LWP				





LANGUAGE

English

8.0 TEST GROUPS

TEST REF.	TEST	A	В	C	D	E	F	G
4.1	Contact Resistance	246	2 4 6	246	246	246		
4.2	Insulation Resistance	9						
4.3	Dielectric Withstanding Voltage	10						
5.1	Insertion Force						1	
5.2	Withdrawal Force						2	
5.3	Durability	3	3	3	3	3		
5.4	Shock			8				
5.5	Vibration			7				
5.6	Terminal Retention Force in Housing (PCB Headers)							1
5.8	Latched header retention force.							1
6.1	Damp Heat	7						
6.2	Dry Heat	5						
6.3	Cold			5				
6.4	Thermal Shock		5					
6.5	Corrosive Atmosphere Sulphur Dioxide (SO ₂)				5			
6.6	Corrosive Atmosphere Hydrogen Sulphide (H ₂ S)					5		
6.7	Solder Heat Resistance	1	1	1	1	1		
6.8	Resistance to Reflow Temperature	1	1	1	1	1		
6.9	Glow Wire							1

	REVISE ON PC ONLY:	TITLE:				
W	SEE SHEET 1		PICOFLEX CONNECTOR SYSTEM PRODUCT SPECIFICATION			
			CUMENT CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX			
REV.	DESCRIPTION	INC	INC. AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION			
	DOCUMENT NUMBER		FILENAME SHEET			
	PS-99020-0011		PS-99020-0011 10 of 14			
		1				
ES-40000-3996 REV. A SHEET 3 95/MAR/10 EC U5-0926 DCBRD03.LWP						

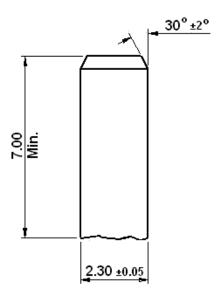


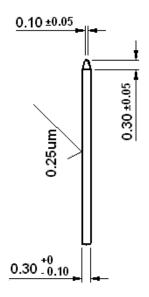


LANGUAGE

English

APPENDIX A - INSERTION/WITHDRAWAL GAUGE SPECIFICATION





Note: Gauge weight = 25 grams minimum

	REVISE ON PC ONLY:	TITLE:			
W	SEE SHEET 1		PICOFLEX CONNEC		M
			CUMENT CONTAINS INFORMATION THA		
REV.	DESCRIPTION	INC. AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION			
	DOCUMENT NUMBER			FILENAME	SHEET
	PS-99020-0011			PS-99020-0011	11 of 14
ES-40000-3996 REV. A SHEET 3 95/MAR/10 EC U5-0926 DCBRD03.LWP					





LANGUAGEEnglish

APPENDIX B – RE-FLOW PROFILES

PROFILE FEATURE	Pb-FREE PROCESS (RoHS) COMPLIANT	Pb-FREE PROCESS (RoHS) COMPATIBLE
Product Series	90779, 91714 and 90814/93405. (90814/93405 standard profile)	90814, 90816/93407 & 91330. (90814/93405 low profile)
Average Ramp Up Rate	3°C/second max.	3°C/second max.
Preheat - Temperature Min ($T_{S min}$) - Temperature Max ($T_{S max}$) - Time (t_{S})	100°C 150°C 60 – 120 seconds	150°C 200°C 60 – 180 seconds
$\label{eq:Time over Liquidus} \begin{tabular}{ll} Time over Liquidus \\ - Temperature (T_L) \\ - Time \ (t_L) \end{tabular}$	183°C 60 – 150 seconds	217°C 60 – 150 seconds
Time from 25°C to Peak Temperature (T _P)	6 minutes max.	8 minutes max.
Peak Temperature (T _P)	230°C max.	260°C max.
Time within 5°C of Peak Temperature (t _P)	30 seconds max.	40 seconds max.
Ramp Down Rate	6°C/second max.	6°C/second max.

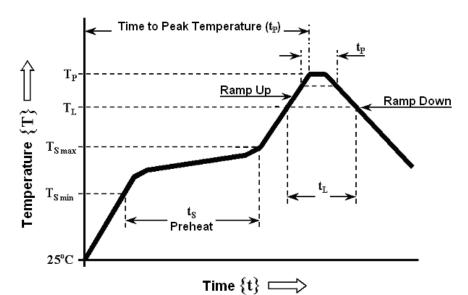
	REVISE ON PC ONLY:	TITLE:				
W	SEE SHEET 1		PICOFLEX CONNEC		М	
			CUMENT CONTAINS INFORMATION THA			
REV.	DESCRIPTION	INC. AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				
	DOCUMENT NUMBER			FILENAME	SHEET	
	PS-99020-0011			PS-99020-0011	12 of 14	
	ES-40000-3996 REV. A SHEET 3 95/MAR/10 EC U5-0926 DCBRD03.LWP					





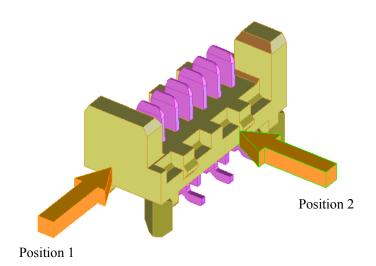
LANGUAGE

English



APPENDIX C - GLOW WIRE TEST POSITIONS

Series 90779, 90814, 93405, 90816, 93407, 91330 and 91714



	REVISE ON PC ONLY:	TITLE:				
W	SEE SHEET 1		PICOFLEX CONNE PRODUCT SPE		M	
			CUMENT CONTAINS INFORMATION THA			
REV.	DESCRIPTION	INC	C. AND SHOULD NOT BE USED WITHOU	JT WRITTEN PERMIS	SION	
	DOCUMENT NUMBER			FILENAME	SHEET	
	PS-99020-0011			PS-99020-0011	13 of 14	
	ES-40000-3996 REV. A SHEET 3 95/MAR/10 EC U5-0926 DCBRD03.LWP					

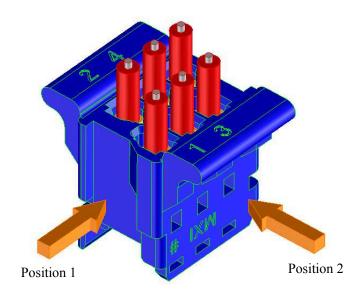




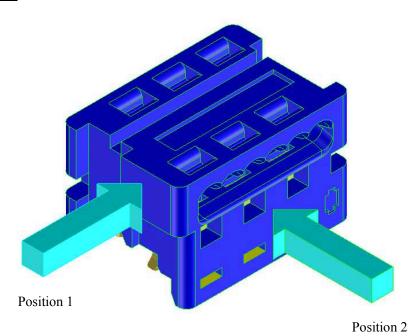
LANGUAGE

English

Series 91821 and 91935



<u>Series 93338</u>



			•		
	REVISE ON PC ONLY:	TITLE:			
W	SEE SHEET 1		PICOFLEX CONNE PRODUCT SPE		M
		THIS DOO	CUMENT CONTAINS INFORMATION THA	AT IS PROPRIETARY	TO MOLEX
REV.	DESCRIPTION	INC. AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION			
	DOCUMENT NUMBER			FILENAME	SHEET
PS-99020-0011				PS-99020-0011	14 of 14
ES-40000-3996 REV. A SHEET 3 95/MAR/10 EC U5-0926 DCBRD03.LWP					